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Enhanced insulation temperature and the reduced thermal conductivity of nanostructured ceramic coating systems



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ABSTRACT

The theoretical model on the size-dependent thermal conductivity of the nanograins and the composites, based on the phonon confinement and the boundary scattering effects, was developed to predict the 68% reduced thermal conductivity of the nanostructured ceramic coatings made of grains of 40–100 nm compared with the conventional ceramic coatings with micron-scale grains. In order to validate the model, the nanostructured zirconia layers and the corresponding conventional layers were sprayed on the same alloy matrixes, and the insulation temperatures were measured at different temperatures up to 1273 K. It was found that insulation temperature of the nanostructured ceramic systems enhanced about 200 K at most compared with that of the conventional ones. And the average enhancement of the insulation effect is in agreement with the theoretical prediction. The nanostructured ceramic coated systems provide the extending application in thermal barrier engineering, thermoelectric devices and other related applications.

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1. Introduction

The low thermal conductivity is one of important properties for thermal barrier engineering and thermoelectric devices, etc. The thermal barrier coatings, made of the Y₂O₃ stabilized ZrO₂ ceramics, are used to provide thermal insulation to the interior metallic components from the hot gas stream in gas turbine engines for aircraft propulsion, power generation, and marine propulsion [1–3]. The use of ceramic top layers, with 100-500 µm thickness, provides major reduction in the surface temperature (100-300 K) of the metallic alloy and makes engine components more durable [2]. The air-plasma-sprayed ceramic layers, with the conventional splat grains in micron-scale, have the low thermal conductivity of about 2 W m⁻¹ K⁻¹ [1]. However, how to reduce the thermal conductivity further and enhance actually the thermal protection efficiency at the given layer thickness, for more exacting application, is still challenge. In order to obtain the lower thermal conductivity of the ceramics, the effort has been paid out by changing the density, the microstructure scale, or the component of the ceramics [4,5]. Although there were reports of the reduced thermal conductivity of nanostructured ceramic layers, the increase of the porosity was as the cost [5], which may affect the mechanical properties of the systems. The study has indicated that the scattering effect of surface or grain boundary can decrease the conductivity

for nanocrystals [6,7]. However, the nanoscale polycrystalline structures, prepared by other method, even showed the higher thermal conductivity [4]. Moreover, the obviously enhanced insulation temperature of the nanostructured ceramic coated systems was few reported. Is the thermal protection effect of the nanostructured ceramic systems indeed better? And what's the underlying physical mechanism? A quantitative theory of reducing thermal conductivity and enhancing insulation temperature, with determinate parameters, is desired not only in engineering application, but also in scientific understanding.

In this paper, the theoretical model on the reduced thermal conductivity of the nanograins and the composites was developed, and the enhanced insulation temperature was predicted. According to the model, the thermal protection effect of the nanostructured and the conventional ceramic coated alloy samples were studied comparatively by measuring the insulation temperature difference between two kinds of samples at the same time at a series of temperatures. The obviously enhanced insulation temperature of the nanostructured ceramic samples was found, and the experimental result agrees with the theoretical prediction.

2. Theoretical model

According to the kinetic formula of the thermal conductivity k = 1/3Cvl, where C is the specific heat, v is the average phonon velocity, and l is the phonon mean free path, considering the phonon confinement and the boundary scattering effect induced by

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Nomenclature k thermal conductivity T_S surface temperature of matrix of the matrix/coat sam-C specific heat of crystals phonon velocity heat flow density per unit time through the surface of ν q 1 phonon mean free math the samples interface roughness scattering coefficient of nanoparti- ΔT temperature gradient along thickness of the samples, p i.e., the insulation temperature interface rough thickness L thickness Ď diameter of nanoparticles thermal resistance phonon mean free path of crystals in Debye model G thermal conduction l_0 β atomic vibration parameter of crystals porosity of the coats S vibration part of melting entropy **Subscripts** Н melting enthalpy nanoparticles n melting temperature T_0 h the bulk materials R ideal gas constant 1 the samples coated with nanostructured ceramics D_0 minimum critical size of crystals 2 the samples coated with conventional ceramics 3 h atomic diameter the samples without ceramic coats the factor related to the roughness scattering coefficient the ceramic coat С α m the alloy matrix T_f furnace temperature, i.e., surface temperature of cerathe air mic coat of the matrix/coat samples

the small size and the large surface ratio, the thermal conductivity k_n of single crystal nanowires, thin films and nanoparticles has been derived by introducing the intrinsic size effect of v and l and combining with the surface scattering effect [6]. k_n is expressed as

$$K_n/k_b = \text{pexp}(-l_0/D)\{\exp[(1-\beta)/(D/D_0-1)]\}^{3/2},$$
 (1)

where k_b is the corresponding bulk value, 0 isthe surface roughness coefficient reflecting the scattering degree, n is the surface rough thickness. D is the diameter of the nanowires or the nanoparticles, or the thickness of the thin films, l_0 is the phonon mean free path of the crystals in the Debye model, $\beta = 2S/$ (3R) + 1 is the atomic vibration parameter with the ideal gas constant R and the vibration part of the melting entropy $S = H/T_0$, H is the melting enthalpy of the crystals and T_0 is the melting temperature, $D_0 = 2h$, 4h, 6h is the minimum critical size of the thin films, the nanowires, and the nanoparticles, respectively, h is the atomic diameter of the crystals [6]. Equation (1) indicates that the thermal conductivity of the nanowires and the nanoparticles decreases with reducing diameter. The experimental and the simulation study has indicated that the thermal conductivity of single-crystal nanowires and thin films is much lower than the corresponding bulk values [8,9], and Eq. (1) has been validated by the molecular dynamic simulation and the experimental results [6,8,9]. The similar trend is estimated for ceramic nanoparticles or nanostructured ceramic layers.

For nano-ceramic layers made of nanoscale grains, Eq. (1) is assuming to be still valid, differently, D is the diameter of the grains, and D_0 = 6h is the minimum critical size of the grains considering that the critical size depends on the dimension [10], p is the interface roughness coefficient among the grains, and η is the interface rough (grain boundary) thickness considering that the mechanism of the interface effect is similar to that of the surface effect [7]. Note that the surface scattering effect is neglected since the nano-layers have the same thickness, of several hundreds of microns, as that of the conventional layers with micron-scale grains. For ZrO₂ crystals, H = 87.5 K J mol⁻¹ [11], T_0 = 2973 K [2], thus S = 29.4 J mol⁻¹ K⁻¹ and β = 3.36, h = 0.4 nm (calculated by the atomic volume [12]) and D_0 = 2.4 nm, I_0 = 18.8 nm (calculated

value based on the bulk thermal conductivity, the specific heat, and the phonon velocity related to the elastic modulus and the density [13]). Equation (1) indicates the thermal conductivity k_n of the nano-layers will decrease with reducing grain diameter D. When $D \to 1$ the bulk and $D \to 1$, $D \to 1$, $D \to 1$, when $D \to 1$ or $D \to 1$, $D \to 1$ or $D \to 1$ o

Considering the increased interface ratio and the boundary scattering effect, the thermal conductivity of the nano-layers can decrease further. In fact, the surface/interface plays an important role in nanoscale heat transport [14]. According to $p = 1 - \alpha \eta/D$ [6], where α is the factor related to the roughness scattering coefficient, $\alpha = 10$ for the surface scattering of the single crystals [6], here $\alpha = 10 \times (\gamma_{gb}/\gamma_{sv})$ is assumed for the grain boundary scattering considering the weaker effect of the grain boundary compared

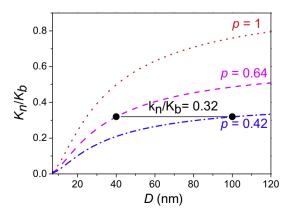


Fig. 1. The thermal conductivity of the nano-ceramics decreases with decreasing grain size and roughness coefficient.

with that of the surface [7], where γ_{gb} and γ_{sv} are the grain boundary energy and the surface energy, respectively, and $\gamma_{gb}/\gamma_{sv}=1/3$ [7], i.e., $p=1-(10/3)\eta/D$. For the grains of D=(40-100) nm, the grain boundary (rough) thickness $\eta=(4.32-17.4)$ nm is estimated based on the related experimental cognition, this roughness is also reasonable in the fabrication of the nanostructures [8]. Therefore, the interface roughness coefficient $p=1-(10/3)\eta/D=(0.64-0.42)$ is predicted, and finally, $k_n/k_b=(0.5-0.76)p=0.32$ as shown in Fig. 1, which shows the thermal conductivity at the corresponding size and the roughness coefficient. The model predicts that the thermal conductivity of nano-ceramics can reduce about 68% compared with the conventional ones, which should be related to the corresponding enhancement of the insulation temperatures. In order to validate the theoretical prediction, the nano-samples were prepared and the thermal insulation temperature was measured.

3. Experimental procedure

The top surfaces of the alloy specimens with the diameter of 40 mm and the thickness of 2.8 mm were coated with the 8 wt.% Y₂O₃ stabilized ZrO₂ (YSZ) layers using the standard air plasma spray method [15]. Two kinds of ceramic layers were prepared by the similar process (Ar/H₂) on the Metco 7M atmospheric plasma spray equipment, and the METCO 9MP-DUAL type feedstock system was used. The microstructure of one kind of layers is in nanoscale (the samples are denoted as S1) prepared from the nanostructured YSZ powder (CM60, Institute of Process Engineering, Chinese Academy of Sciences), and the other is in micron-scale (S2) prepared from the conventional YSZ powder with the larger granularity (Metco 204CNS, Sulzer Metco, Westbury, NY, USA) by means of the standard parameters suggested by the manufacturer of the powder and torch (Sulzer Metco). The thickness of the both ceramic layers is about 200 µm, and the morphologies of the both are also similar except the difference of the scale of the grains, the structures will be shown in the next part. The NiCoCrAlY bond layers between the ceramic top layers and the Ni-based superalloy matrixes were prepared using the high velocity oxygen fuel process, and the thickness is about 30 µm. The total thickness of the coated samples is about 3 mm. The structure of the samples was observed by the FEI Tecnai G2 F20 transmission electron microscope (TEM), the S-570 scanning electron microscope (SEM), and the Neophot21 incident-light microscope.

In order to test the thermal insulation temperature, the two kinds of samples (S1 and S2) were placed in the stokehole of the KSW5-12 box resistance furnace at the same time and fixed on the furnace door, with the ceramic layers facing toward the hearth and the alloy matrixes exposing to the air, i.e., the heat flux is along the direction of the thickness of the samples, the thermocouple of controlling temperature of the resistance furnace was placed on the surface of the ceramic layers. The furnace were heated to 773 K, 873 K, 973 K, 1073 K, 1173 K, 1273 K, respectively, and then held at each temperature for about 20 min. The surface temperatures of the ceramic layers of the two samples (the same, i.e., the furnace temperatures T_f) were recorded every 30 s. The corresponding matrix temperatures of the two samples T_{S1} and T_{S2} were also measured simultaneously by the UJ36a DC potentiometer to compare their thermal insulation effect. Moreover, the samples without the ceramic coats (S3) were also prepared and T_{S3} was also measured to demonstrate the thermal insulation effect of the ceramic layers.

4. Results and discussion

Fig. 2(a)–(c) shows the cross-section structure of the samples, the surface morphology and the microstructure of the nanostruc-

tured ceramic layers, respectively. It can be seen from Fig. 2(b) that there is not obvious difference in the morphology between the nano-layers and the conventional ones, the layers include the molten zone of the ceramic powder and the unmolten zone of the agglomerated powder. However, the grain diameter of the nanoceramics is in the range of about 40-100 nm as shown in Fig. 2(c), consistent with the requirement of the theoretical design, not like the conventional ceramic layers with the micro-scale bulk grains, and the grain boundary thickness is also consistent with the theoretical estimation. Fig. 3 shows the comparison of the thermal insulation effect between S1 and the S2 during heating. It can be seen that the insulation temperatures of the nanostructured ceramic samples enhance about 36–201 K (T_{S2} – T_{S1}) compared with that of the conventional ones at the series of the furnace temperatures. which can also be found from Table 1. Table 2 shows the insulation effect of S1 and S3 after holding 20 min at the given temperatures. The result indicates that the insulation temperature $(T_f - T_{S1})$ of the nanostructured samples enhances with increasing temperature, and reaches 159-277 K corresponding to 773-1273 K, respectively. Fig. 4 shows the enhanced insulation temperature of the nanostructured samples compared with the samples without ceramic coatings during holding temperatures. The insulation temperature increases obviously in 5 min of the beginning, reaches 32-240 K at most corresponding to 773–1273 K, respectively, and does not change nearly after 15 min. In a word, the nanostructured ceramic coated samples have indeed the better thermal protection effect.

For S1 (nano) and S2 (conventional), the experimental conditions such as the size of the samples, the thickness of the ceramic layers, the heating temperature, and the heat flux are all same, the different insulation effects are only resulted from the different thermal conductivities of two samples with different structured ceramic layers. According to the Fourier's Law, the heat flux density q per unit time through the surface of the samples is expressed as $q = -k\Delta T/L$ with the thermal conductivity k and the thickness L of the samples [16], ΔT is the temperature difference along the direction of the thickness (i.e., the insulation temperature), $\Delta T_i = -T_{Si} - T_f$, where T_{Si} is the matrix temperature of the samples with the subscript i = 1, 2 for S1 and S2, respectively, and the ceramic surface temperature is represented by the furnace temperature T_f . As above mentioned, $q_1 = q_2$, $L_1 = L_2$, therefore,

$$k_1/k_2 = \Delta T_2/\Delta T_1,\tag{2}$$

i.e., the ratio of the thermal conductivity of S1 to that of S2 can be calculated by the inverse of the ratio of their insulation temperatures. The average value of k_1/k_2 is 0.34 as shown in Table 2, i.e., the insulation temperature of the nano-samples enhances 66%. The value is almost in agreement with the theoretical prediction of $k_n/k_b = 0.32$ based on Eq. (1), the further analysis was carried out combining with the effect of the alloy matrix and the porosity as following.

According to the parallel model of the effective thermal conductivity of the composites including the ceramic layers and the alloy matrixes [17], the effective thermal resistance r, vertical to the direction of the heat flux, can be expressed $r = r_c + r_m$ with the subscripts c and m representing the ceramics and the matrixes, respectively. The above equation can also be expressed as $1/G = 1/G_c + 1/G_m$ with the thermal conductance G = 1/r [18]. Considering that k = GL with the Kapitza length being taken as the thickness L [18], there is $L/k = L_c/k_c + L_m/k_m$, where $L = L_c + L_m = 3$ mm is the total thickness of the samples, $L_c = 0.2$ mm is the thickness of the ceramic layers, and $L_m = 2.8$ mm is the thickness of the matrixes. Therefore, the effective thermal conductivity k of the samples is

$$k = Lk_c k_m / (L_c k_m + L_m k_c), \tag{3}$$

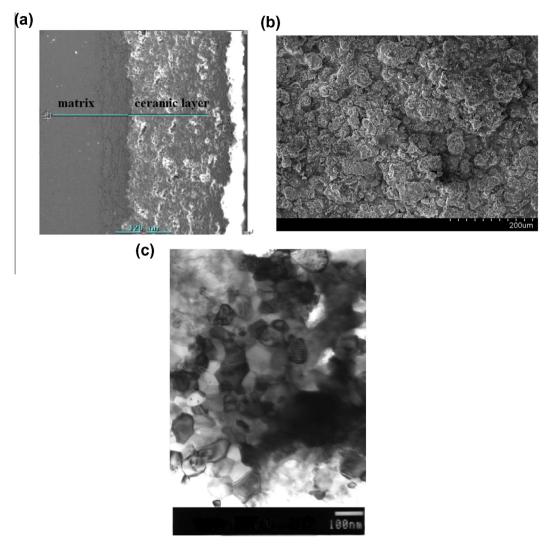


Fig. 2. (a) The cross-section structure of the nano-ceramic coated samples obtained by the incident-light microscope (scale bar 120 μm). (b) The surface morphology of the nano-ceramic layers in the SEM micrograph (scale bar 20 μm) showing no obvious difference with the conventional layers. (c) The microstructure of the nano-ceramics in the TEM micrograph (scale bar 100 nm) showing the grain diameter about 40–100 nm.

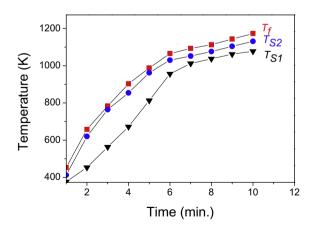


Fig. 3. The matrix temperatures of the nano-samples (T_{51}) lower than those of the conventional ones (T_{52}) at the same furnace temperatures (T_f) .

where the thermal conductivity k_m of the Ni matrix is 90.7 W m⁻¹ - K⁻¹ [19], k_m , L, L_c and L_m for S1 and S2 are all same, only the thermal conductivity k_c of the ceramic layers are different for the nanostructured and the conventional ones. Let k_{cn} denote the thermal conductivity

tivity of the nanostructured ceramic layers, the corresponding left side of Eq. (3) is k_1 , $k_{cb} = 2$ W m⁻¹ K⁻¹ [1] denotes the thermal conductivity of the conventional ceramic layers with the micron-scale structure (i.e., the bulk structure), the corresponding left side of Eq. (3) is k_2 , combining with the experimental result of $k_1/k_2 = 0.34$, there is also $k_{cn}/k_{cb} = 0.34$ approximately.

Considering that the porosity of the ceramic layers changes more or less with the change of the microstructure, the effect on the thermal conductivity, although the effect may be weak compared with the size effect of the ceramic particles when the porosity and its change are both small, was considered further. The porosity was estimated based on the image analyzing of the cross-section microstructure of the ceramic layers. The estimated porosities are 8% and 14% for the nano-ceramics and the conventional ones, respectively, which agree with the previous discussions [20,1]. According to the simple mixture rule, the thermal conductivity k_{cn} (k_{cb}) of the ceramic layers, made of the particles and the pores, is expressed as

$$K_{cn} = (1 - f_n)k_n + f_n k_a,$$
 (4.1)

$$K_{cb} = (1 - f_b)k_b + f_b k_a, (4.2)$$

Table 1 Comparison of the insulation temperatures $(T_f - T_{Si})$ and the thermal conductivity between S1 (nano) and S2 (conventional).

$T_f(K)$	453	658	783	903	988	1065	1093	1113	1143	1173
$T_{S2}-T_{S1}$ (K)	36	167	201	182	149	74	40	39	42	53
$-\Delta T_1 = T_f - T_{S1} \text{ (K)}$	77	205	220	231	175	109	81	76	81	95
$-\Delta T_2 = T_f - T_{S2} \text{ (K)}$	41	38	19	49	26	35	41	37	39	42
$k_1/k_2 = \Delta T_2/\Delta T_1$	0.53	0.19	0.09	0.21	0.15	0.32	0.51	0.49	0.48	0.44

Table 2Comparison of the matrix temperatures of S1 (nano) and S3 (without ceramics) after holding 20 min at the given furnace temperatures.

$T_f(K)$	806	894	996	1097	1196	1294
$T_{S1}(K)$	647	710	792	876	951	1017
T_{S3} (K)	666	754	833	945	1060	1140
$T_f - T_{S1}$ (K)	159	184	204	221	245	277

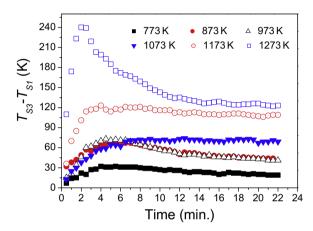


Fig. 4. Enhanced insulation temperatures (T_{S3} – T_{S1}) of S1 (nano) compared with those of S3 (without ceramics) during holding temperatures.

where the porosity f_n = 0.08 and f_b = 0.14 for the nanostructured layers and the conventional ones, respectively, k_a = 0.026 W m⁻¹ - K⁻¹ is the thermal conductivity of the air [21], k_n and k_b (2.3 W m⁻¹ K⁻¹ [2]) are the thermal conductivity of the ceramic nanoparticles and the corresponding dense bulk, respectively. Combining Eqs. (4.1) and (4.2) with k_{cn}/k_{cb} = 0.34, the pure size effect can be obtained as k_n/k_b = 0.32, which is just in agreement with the theoretical prediction based on Eq. (1). Note that the effect of the change of the pores distribution is neglected, since the effect is weak based on the effective thermal conductivity calculation of the porous composite medium when the porosity and its change are both smaller [21].

The result indicates that the thermal conductivity of the ceramics can be reduced and the thermal insulation effect can be enhanced effectively by the nanostructurization at the given thickness and porosity, the decrease of the microstructure scale or the relatively increase of the interface roughness suppresses the phonon transport and thus the lattice thermal conductivity. In fact, the enhanced thermal shock resistance of the nanostructured ceramics has been achieved [22], which is resulted from that the nanostructure reduces the thermal conductivity, thus protects the samples during the thermal shock.

5. Conclusion

In summary, a size-dependent thermal conductivity model was developed to predict the ultralow thermal conductivity and the obviously improved thermal insulation effect of the nanostructured ceramic layers. According to the model, the ceramics layers

made of nanograins were fabricated and the thermal insulation temperature was measured comparatively with that of the conventional ceramic layers, the agreement with the prediction was found. The designed nanostructurization based on the theory can enhance effectively thermal protection property of the coating structures and promote the application of nanomaterials in thermal barrier and energy engineering.

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